507806277 03/19/2023

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT7853407

| SUBMISSION TYPE: | NEW ASSIGNMENT |
|-----------------------|----------------|
| NATURE OF CONVEYANCE: | ASSIGNMENT |

CONVEYING PARTY DATA

| Name | Execution Date |
|----------------|----------------|
| TE LUNG FANG | 03/08/2022 |
| CHIH CHIEH YEN | 03/08/2022 |
| JEN-HAO YEH | 03/08/2022 |
| WEI-YI WEI | 03/08/2022 |

RECEIVING PARTY DATA

| Name: | REALTEK SEMICONDUCTOR CORPORATION | |
|-----------------|--|--|
| Street Address: | NO. 2, INNOVATION RD. II, HSINCHU SCIENCE PARK | |
| City: | HSINCHU | |
| State/Country: | TAIWAN | |
| Postal Code: | 30076 | |

PROPERTY NUMBERS Total: 1

| Property Type | Number |
|---------------------|----------|
| Application Number: | 18186180 |

CORRESPONDENCE DATA

Fax Number: (949)250-3178

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 9493872885

Email: ahong@wpatca.com

Correspondent Name: WPAT, PC INTELLECTUAL PROPERTY ATTORNEYS

Address Line 1: 1100 QUAIL STREET, SUITE 202

Address Line 4: NEWPORT BEACH, CALIFORNIA 92660

| ATTORNEY DOCKET NUMBER: | 18506-2399 |
|---------------------------|--------------|
| NAME OF SUBMITTER: | ANTHONY KING |
| SIGNATURE: /Anthony King/ | |
| DATE SIGNED: | 03/19/2023 |

Total Attachments: 2

source=110A-253US-Assignment#page1.tif source=110A-253US-Assignment#page2.tif

PATENT REEL: 063027 FRAME: 0515

507806277

ASSIGNMENT

WHEREAS, I(we), <u>FANG, TE LUNG</u>, <u>YEN, CHIH CHIEH</u>, <u>YEH, JEN-HAO</u> and <u>WEI, WEI-YI</u> whose post office address(es) appear(s) below, hereinafter referred to as Assignor, have invented certain new and useful invention entitled

COMMUNICATION APPARATUS AND ASSOCIATED METHOD

| | NVENTION) for which an application for with unless at least one of the following is Patent was | | ters Patent /Utility Patent |
|--|--|-----------------------|-----------------------------|
| executed on: | | | |
| ☐ filed on: ☐ established by PCT In United States of America | Serial No.: ternational Patent Application No.: | filed: | designating the |
| 🔲 issued on | as U.S. Patent No.: | | |
| INNOVATION RD. II, HS | EMICONDUCTOR CORPORATION OF THE CORPORATION OF THE CONTROL OF THE CONTROL OF THE CORPORATION OF THE CORPORAT | HU 30076, TA | IWAN hereinafter referred |
| MOMENTANIA C | and the second s | . لو د الانجاد الجوال | |

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I (we), ASSIGNOR, by these presents do sell, assign and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application for the full term or terms for which the same may be granted, including all priority rights under any International Convention.

ASSIGNOR further covenants that no assignments, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment;

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify and communicate to ASSIGNEE at ASSIGNEE'S request documents and information concerning the INVENTION that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance, litigation and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all Letters Patent referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE'S sole use and behoof; and for the use and behoof of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

| Assignor Name FANG, TE LUNG | Address NO. 2, INNOVATION RD. II, HSINCHU SCIENCE PARK, HSINCHU 30076, TAIWAN |
|--|---|
| Signature of Assignor (X) FANG, TELUNG | Date of Signature (X) 2022/03/08 |
| Name of Witness (optional) | Name of Witness (optional) |
| Signature of Witness (optional) | Signature of Witness (optional) |

PATENT REEL: 063027 FRAME: 0516

| Assignor Name | *************************************** | |
|---------------------------------|---|--|
| YEN, CHIH CHIEH | Address | |
| rea, chin chien | NO. 2, INNOVATION RD. II, HSINCHU | |
| | SCIENCE PARK, HSINCHU 30076, TAIWAN | |
| Signature of Assignor | Date of Signature | |
| (X) YEV CHIH CHIEH | (X) 2022/03/08 | |
| Name of Witness (optional) | Name of Witness (optional) | |
| Signature of Witness (optional) | Signature of Witness (optional) | |
| Assignor Name | Address | |
| YEH, JEN-HAO | \$ control of the | |
| FERI, JEN-RAO | NO. 2, INNOVATION RD. II, HSINCHU | |
| | SCIENCE PARK, HSINCHU 30076, TAIWAN | |
| Signature of Assignor | Date of Signature | |
| (x) Yeh, Jen-Hao | (X) 2022/03/08 | |
| Name of Witness (optional) | Name of Witness (optional) | |
| Signature of Witness (aptional) | Signature of Witness (optional) | |
| | | |
| Assignor Name | Address | |
| WEI, WEI-YI | NO. 2, INNOVATION RD. II, HSINCHU | |
| 7. mm - 1. mm - 1. mm | SCIENCE PARK, HSINCHU 30076, TAIWAN | |
| Signature of Assignor | Date of Signature | |
| (X) WEI→ WĒI- (I | (X) 2022/03/08 | |
| Name of Witness (optional) | Name of Witness (optional) | |
| Signature of Witness (optional) | Signature of Witness (optional) | |